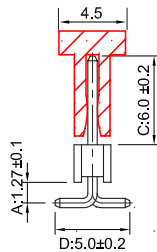
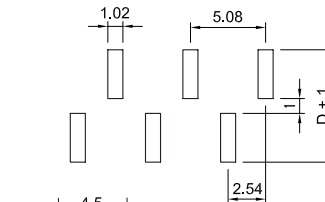
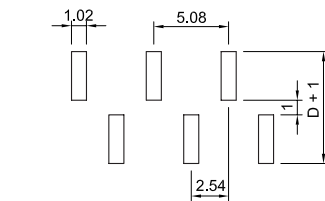
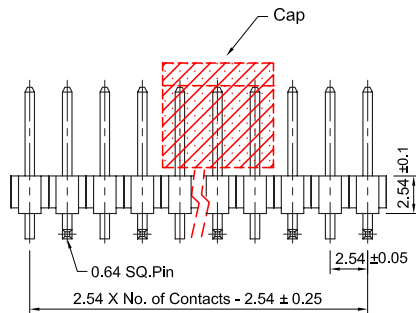
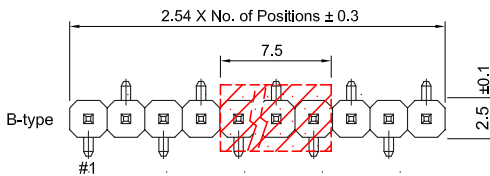
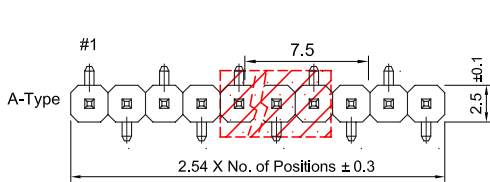


Recommended P.C. Board SMD Layout



Specifications

Current Rating: 3 Amps
 Insulator Resistance: 1000 Megohms min.
 Contact Resistance: 20 m ohms max.
 Dielectric Withstanding: AC 600V
 Operating Temperature: -40°C ~ +105°C
 Contact Material: Brass
 Insulator Material: Polyester, UL 94V-0 Nylon-6T
 Contact Plated: *see options below
 Standard: Full Gold Flash

Part Numbering System

SSC - X - XX - A-C-D - XXXN

Series

Pin Type Option:

A = A Type
 B = B Type

No. of Pins

Terminal Dimensions Required

A = ... , C = ... , D = ...

Contact Plating

Insulator Material:

N = High Temperature Nylon-6T

Packing Method:

Nil = Bulk
 B = Tube
 T = Tape & Reel

Cap Option:

Nil = No Cap
 P = Plastic

Example: SSC-12-1.27-6.00-5.00-GPBN
 with 12pins, A = 1.27, C = 6.00, D = 5.00

* Contact Plating Option	Full Gold Plating	Gold Plated on Contact Area Tin Plated on Solder Area	Full Tin Plating
G : Gold Flash G10: Gold 10u" G15: Gold 15u" G30: Gold 30u"	S: Gold Flash S10: Gold 10u" S15: Gold 15u" S30: Gold 30u"	T: Tin 100u"	

General Tolerance	
X. ± 0.50	X." ± 5'
.X ± 0.20	.X" ± 2'
.XX ± 0.10	.XX" ± 1'
Units : mm	

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